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Doping designed half-Heusler insulators YONGGANG YU, XI-
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ZUNGER, University of Colorado, Boulder, CO — The 18-valence-electron 1:1:1
compounds of the type III-X-V, IV-X-IV, IV-IX-V and V-IX-IV include thermo-
electric materials, topological insulators, and recently a high mobility p-type trans-
parent conductor TaIrGe (arXiv:1406.0872), yet their intrinsic doping trends are
poorly known or understood. Using the “modern theory of doping” that addresses
via DFT and HSE the thermodynamic formation energies and the DFT-corrected
transition levels in the gap, we find the following interesting trends: (1) High atomic
number compounds such as TaIrGe made of metallic elements can surprisingly have
a large band gap (direct) of ~ 2.5 eV. (2) Half-Heusler such as $A^{(IV)}B^{(X)}C^{(IV)}$ is
naturally n-type if its DFT calculated chemical stability field resides within the A-
rich or B-rich domain of the stability triangle, while it is p-type if it resides within
the C-rich domain. Such calculations provide a good metric. (3) When the B atom
[at $(1/4,1/4,1/4)$] is as large as Ir or Pt, the compound prefers p-type because the
C-on-A antisite [such as $Ge_{Ta}^{(1-)}$] is a shallow acceptor producing holes yet the hole-
killer donor of B-interstitial is unfavorable. (4) When B=Ni or Co, the compound
favors n-type due to the dominance of B-interstitial defects (e.g. TiCoSb). We will
show the calculated leading defect types and the dependence of carrier concentra-
tions on chemical conditions for newly predicted half-Heusler insulators. This study
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